Unbuffered inverter Rev. 12 — 9 April 2013

Product data sheet

1. General description

The 74LVC1GU04 is a single unbuffered inverter.

The input can be driven from either 3.3 V or 5 V devices. This feature allows the use of this device in a mixed 3.3 V and 5 V environment.

2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- ± 24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Input accepts voltages up to 5 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

| Table 1. Ordering | information | | | |
|-------------------|-------------------|--------|--|----------|
| Type number | Package | | | |
| | Temperature range | Name | Description | Version |
| 74LVC1GU04GW | –40 °C to +125 °C | TSSOP5 | plastic thin shrink small outline package; 5 leads; body width 1.25 mm | SOT353-1 |
| 74LVC1GU04GV | –40 °C to +125 °C | SC-74A | plastic surface-mounted package; 5 leads | SOT753 |
| 74LVC1GU04GM | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm | SOT886 |
| 74LVC1GU04GF | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1 \times 0.5$ mm | SOT891 |
| 74LVC1GU04GN | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body 0.9 \times 1.0 \times 0.35 mm | SOT1115 |
| 74LVC1GU04GS | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body $1.0\times1.0\times0.35$ mm | SOT1202 |
| 74LVC1GU04GX | –40 °C to +125 °C | X2SON5 | X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body $0.8 \times 0.8 \times 0.35$ mm | SOT1226 |



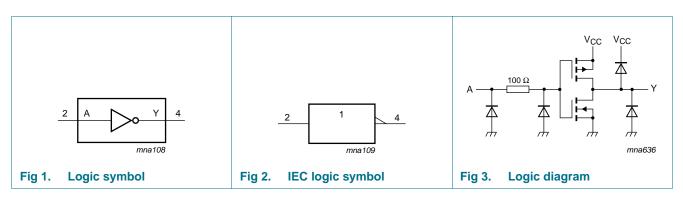


Marking 4.

| Type number Marking ^[1] | |
|--|--|
| | |
| 74LVC1GU04GW VD | |
| 74LVC1GU04GV VU4 | |
| 74LVC1GU04GM VD | |
| 74LVC1GU04GF VD | |
| 74LVC1GU04GN VD | |
| 74LVC1GU04GS VD | |
| 74LVC1GU04GX VD | |

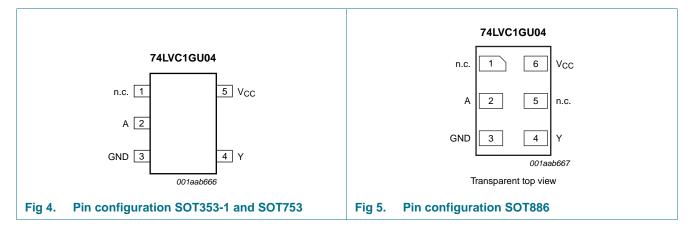
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

Functional diagram 5.



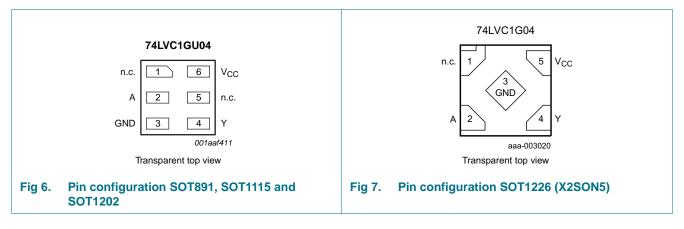
Pinning information 6.

6.1 Pinning



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6.2 Pin description

| Symbol | Pin | | Description | |
|-----------------|-------------------|-------|----------------|--|
| | TSSOP5 and X2SON5 | XSON6 | | |
| n.c. | 1 | 1 | not connected | |
| A | 2 | 2 | data input | |
| GND | 3 | 3 | ground (0 V) | |
| Y | 4 | 4 | data output | |
| n.c. | - | 5 | not connected | |
| V _{CC} | 5 | 6 | supply voltage | |

7. Functional description

Table 4.Function table

| Input (A) | Output (Y) |
|-----------|------------|
| L | н |
| Н | L |

[1] H = HIGH voltage level; L = LOW voltage level.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| | | | | | , |
|------------------|-------------------------|---|--------------------|-----------------------|------|
| Symbol | Parameter | Conditions | Min | Max | Unit |
| V _{CC} | supply voltage | | -0.5 | +6.5 | V |
| I _{IK} | input clamping current | V _I < 0 V | - | -50 | mA |
| VI | input voltage | | <u>[1]</u> –0.5 | +6.5 | V |
| I _{OK} | output clamping current | $V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V | - | ±50 | mA |
| Vo | output voltage | Active mode | <u>[1][2]</u> –0.5 | V _{CC} + 0.5 | V |
| lo | output current | $V_{O} = 0 V$ to V_{CC} | - | ±50 | mA |
| I _{CC} | supply current | | - | +100 | mA |
| I _{GND} | ground current | | - | -100 | mA |
| P _{tot} | total power dissipation | $T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$ | [3] _ | 250 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| | | | | | |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When $V_{CC} = 0$ V (Power-down mode), the output voltage can be 5.5 V in normal operation.

[3] For TSSOP5 and SC-74A packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K.

For XSON6 and X2SON5 packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

| 0 | Deservation | O and difference | B.# ! | T | N4 | 11 |
|-----------------------|-------------------------------------|--|-------|----------|-----------------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| V_{CC} | supply voltage | | 1.65 | - | 5.5 | V |
| VI | input voltage | | 0 | - | 5.5 | V |
| Vo | output voltage | Active mode | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | - | +125 | °C |
| $\Delta t / \Delta V$ | input transition rise and fall rate | V_{CC} = 1.65 V to 2.7 V | 0 | - | 20 | ns/V |
| | | $V_{CC} = 2.7 \text{ V} \text{ to } 5.5 \text{ V}$ | 0 | - | 10 | ns/V |

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10. Static characteristics

Static characteristics Table 7.

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ <mark>[1]</mark> | Max | Unit |
|----------------------|--|---|----------------------|----------------------|----------------------|------|
| T _{amb} = - | 40 °C to +85 °C | | | | | |
| VIH | HIGH-level input voltage | V_{CC} = 1.65 V to 5.5 V | $0.75 \times V_{CC}$ | - | - | V |
| VIL | LOW-level input voltage | V_{CC} = 1.65 V to 5.5 V | - | - | $0.25 \times V_{CC}$ | V |
| V _{OH} | HIGH-level output voltage | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | |
| | | I _O = -100 μA; V _{CC} = 1.65 V to 5.5 V | $V_{CC}-0.1$ | - | - | V |
| | | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.2 | - | - | V |
| | | $I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.9 | - | - | V |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | 2.2 | - | - | V |
| | | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.3 | - | - | V |
| | $I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | 3.8 | - | - | V | |
| V _{OL} | LOW-level output voltage | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | |
| | | I _O = 100 μA; V _{CC} = 1.65 V to 5.5 V | - | - | 0.1 | V |
| | | $I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.45 | V |
| | | $I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.3 | V |
| | | $I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | - | - | 0.4 | V |
| | | $I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.55 | V |
| | | $I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | - | - | 0.55 | V |
| l | input leakage current | $V_{\rm I}$ = 5.5 V or GND; $V_{\rm CC}$ = 0 V to 5.5 V | - | ±0.1 | ±5 | μΑ |
| I _{CC} | supply current | $V_{I} = 5.5 V \text{ or GND}; I_{O} = 0 A;$ $V_{CC} = 1.65 V \text{ to } 5.5 V$ | - | 0.1 | 10 | μΑ |
| CI | input capacitance | V_{CC} = 3.3 V; V_{I} = GND to V_{CC} | - | 6 | - | pF |
| T _{amb} = – | 40 °C to +125 °C | | | | | |
| VIH | HIGH-level input voltage | V_{CC} = 1.65 V to 5.5 V | $0.8\times V_{CC}$ | - | - | V |
| V _{IL} | LOW-level input voltage | V_{CC} = 1.65 V to 5.5 V | - | - | $0.2\times V_{CC}$ | V |
| V _{он} | HIGH-level output voltage | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | |
| | | I _O = -100 μA; V _{CC} = 1.65 V to 5.5 V | $V_{CC}-0.1$ | - | - | V |
| | | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 0.95 | - | - | V |
| | | I_O = -8 mA; V_{CC} = 2.3 V | 1.7 | - | - | V |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | 1.9 | - | - | V |
| | | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.0 | - | - | V |
| | | $I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | 3.4 | | - | V |

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Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ <mark>[1]</mark> | Max | Unit |
|-----------------|---|---|-----|----------------------|------|------|
| V _{OL} | LOW-level output voltage | $V_{I} = V_{IH}$ or V_{IL} | | | | |
| | I _O = 100 μA; V _{CC} = 1.65 V to 5.5 V | - | - | 0.1 | V | |
| | $I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.7 | V | |
| | | $I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.45 | V |
| | | $I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | - | - | 0.6 | V |
| | | $I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.80 | V |
| | | $I_0 = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | - | - | 0.80 | V |
| I | input leakage current | V_{I} = 5.5 V or GND; V_{CC} = 0 V to 5.5 V | - | ±0.1 | ±5 | μA |
| I _{CC} | supply current | $V_1 = 5.5 V \text{ or GND}; I_0 = 0 A;$ $V_{CC} = 1.65 V \text{ to } 5.5 V$ | - | - | 200 | μΑ |

[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 11.

| Symbol | Parameter | Conditions | | –40 °C to +85 °C | | | –40 °C to +125 °C | | Unit |
|-----------------|-------------------------------|---|------------|------------------|----------------------|-----|-------------------|-----|------|
| | | | | Min | Typ <mark>[1]</mark> | Max | Min | Max | |
| t _{pd} | propagation delay | A to Y; see Figure 8 | [2] | | | | | | |
| | V_{CC} = 1.65 V to 1.95 V | | 0.3 | 1.7 | 5.0 | 0.3 | 6.5 | ns | |
| | | V_{CC} = 2.3 V to 2.7 V | | 0.3 | 1.3 | 4.0 | 0.3 | 5.5 | ns |
| | | $V_{CC} = 2.7 V$ | | 0.5 | 1.7 | 5.0 | 0.5 | 6.5 | ns |
| | | V_{CC} = 3.0 V to 3.6 V | | 0.5 | 1.6 | 3.7 | 0.5 | 5.0 | ns |
| | | V_{CC} = 4.5 V to 5.5 V | | 0.5 | 1.3 | 3.0 | 0.5 | 4.0 | ns |
| C _{PD} | power dissipation capacitance | $V_I = GND$ to V_{CC} ; $V_{CC} = 3.3 V$ | <u>[3]</u> | - | 14.9 | - | - | - | pF |

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).
 - $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .



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12. Waveforms

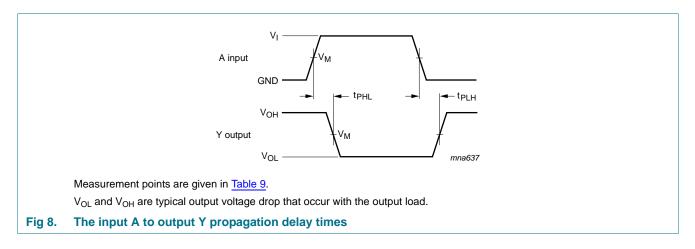
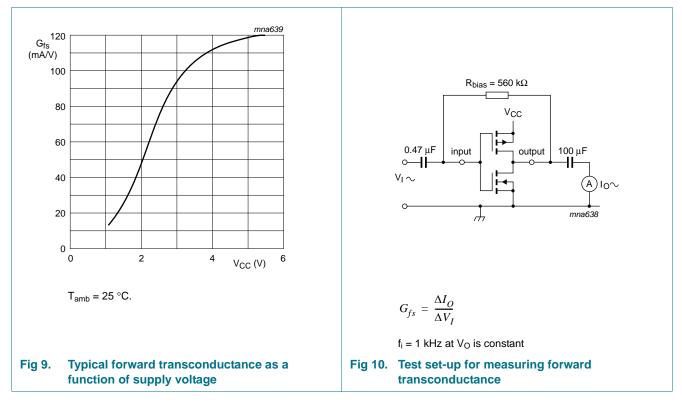


Table 9. Measurement points

| Supply voltage | Input | Output | |
|------------------|--------------------|---------------------|--|
| V _{cc} | V _M | V _M | |
| 1.65 V to 1.95 V | $0.5 	imes V_{CC}$ | $0.5 \times V_{CC}$ | |
| 2.3 V to 2.7 V | $0.5 	imes V_{CC}$ | $0.5 	imes V_{CC}$ | |
| 2.7 V | 1.5 V | 1.5 V | |
| 3.0 V to 3.6 V | 1.5 V | 1.5 V | |
| 4.5 V to 5.5 V | $0.5 	imes V_{CC}$ | $0.5 	imes V_{CC}$ | |



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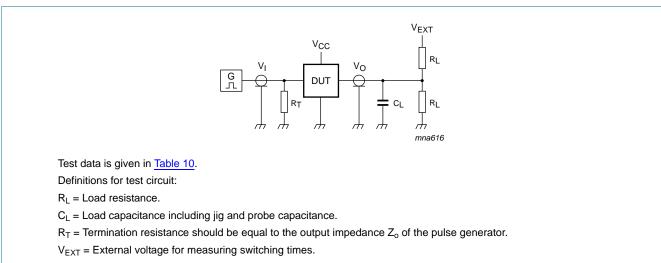


Fig 11. Test circuit for measuring switching times

Table 10. Test data

| Supply voltage | Input | | Load | | V _{EXT} |
|------------------|-----------------|---------------|-------|-------|-------------------------------------|
| V _{CC} | VI | $t_r = t_f$ | CL | RL | t _{PLH} , t _{PHL} |
| 1.65 V to 1.95 V | V _{CC} | \leq 2.0 ns | 30 pF | 1 kΩ | open |
| 2.3 V to 2.7 V | V _{CC} | \leq 2.0 ns | 30 pF | 500 Ω | open |
| 2.7 V | 2.7 V | \leq 2.5 ns | 50 pF | 500 Ω | open |
| 3.0 V to 3.6 V | 2.7 V | \leq 2.5 ns | 50 pF | 500 Ω | open |
| 4.5 V to 5.5 V | V _{CC} | ≤ 2.5 ns | 50 pF | 500 Ω | open |

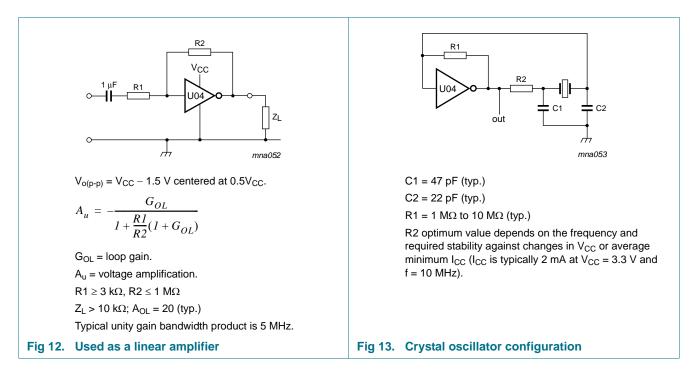


13. Application information

Some applications are:

- Linear amplifier (see Figure 12)
- In crystal oscillator design (see Figure 13)

Remark: All values given are typical unless otherwise specified.



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14. Package outline

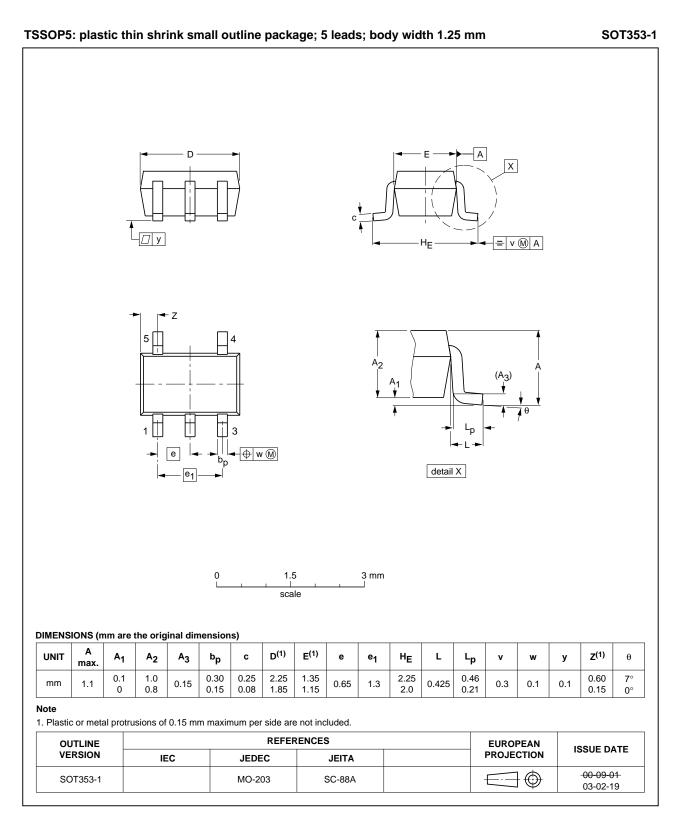
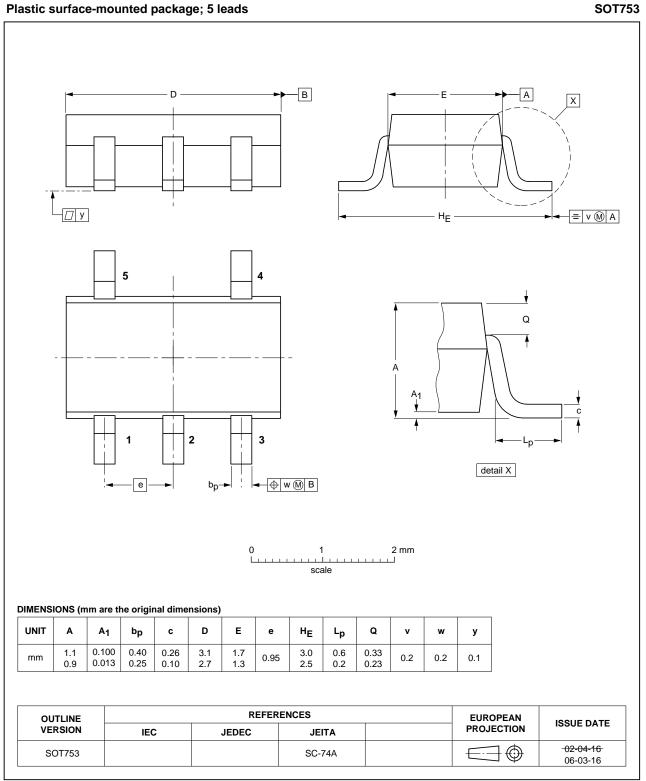


Fig 14. Package outline SOT353-1 (TSSOP5)

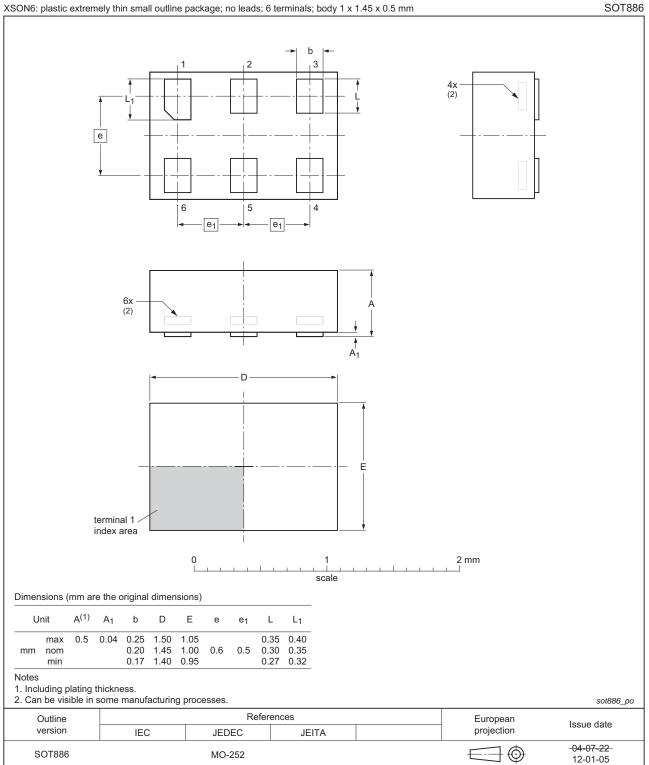
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Plastic surface-mounted package; 5 leads

Fig 15. Package outline SOT753 (SC-74A)

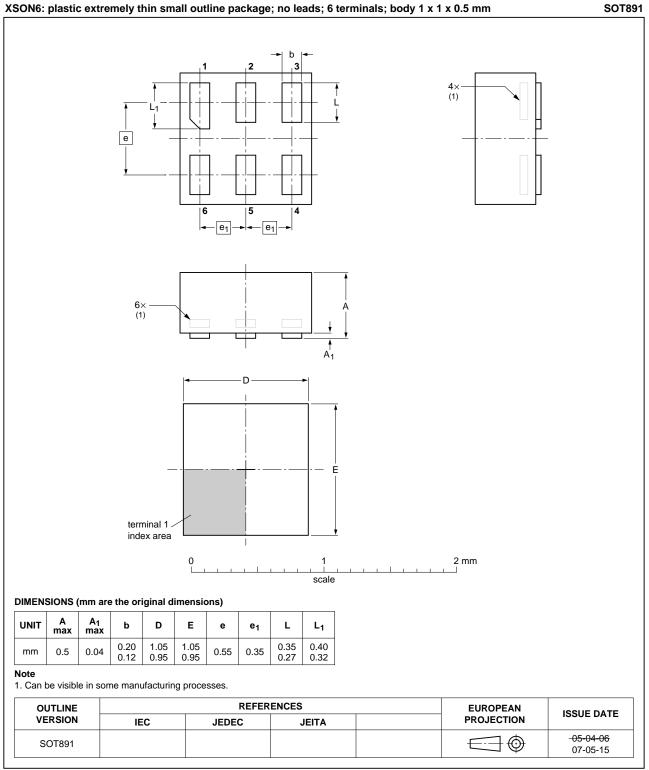
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XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

Fig 16. Package outline SOT886 (XSON6)

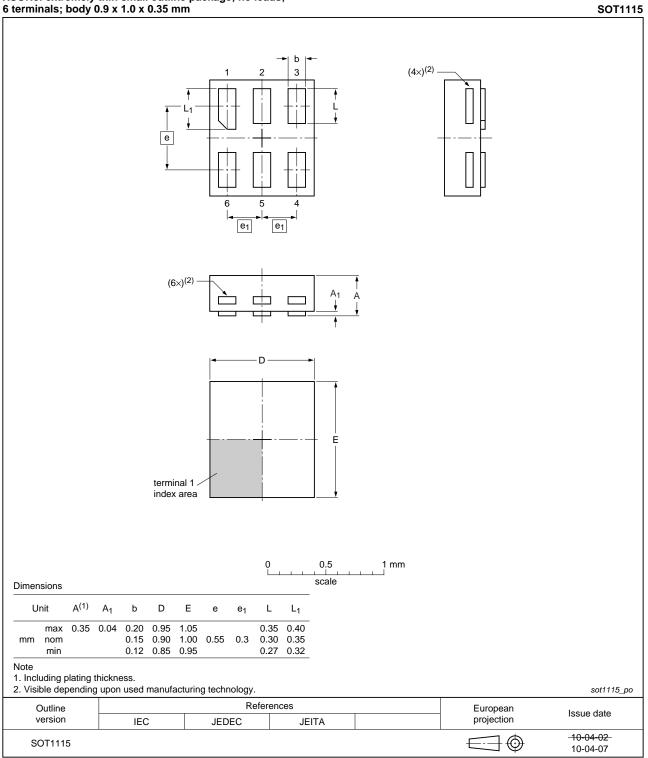
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XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1 x 0.5 mm

Fig 17. Package outline SOT891 (XSON6)

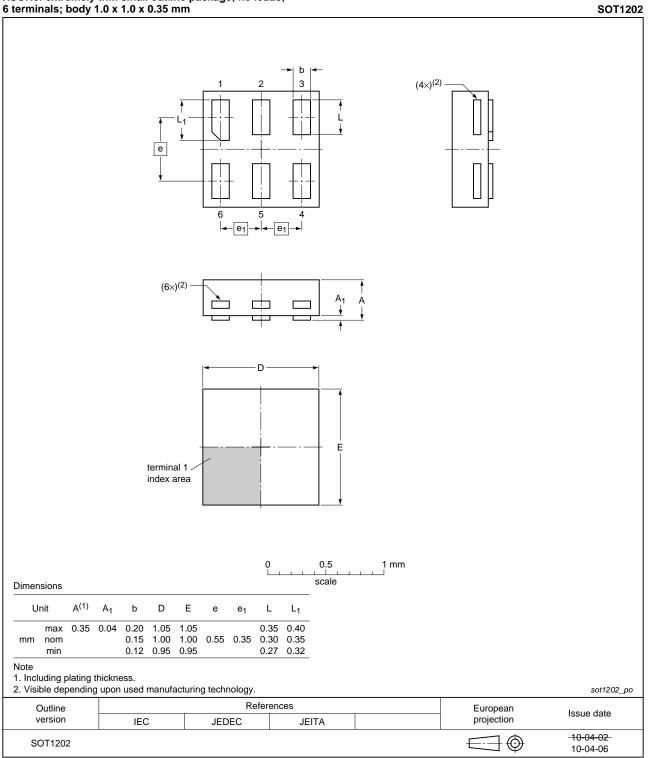
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XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

Fig 18. Package outline SOT1115 (XSON6)

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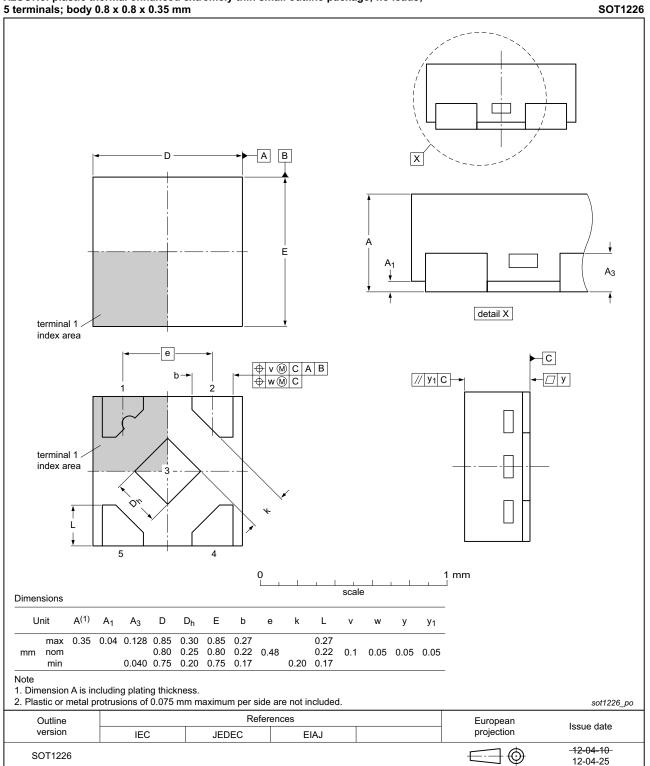
XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 19. Package outline SOT1202 (XSON6)

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X2SON5: plastic thermal enhanced extremely thin small outline package; no leads;

Fig 20. Package outline SOT1226 (X2SON5)

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15. Abbreviations

| Table 11. Abbreviations | | | |
|-------------------------|---|--|--|
| Acronym | Description | | |
| CMOS | Complementary Metal Oxide Semiconductor | | |
| DUT | Device Under Test | | |
| ESD | ElectroStatic Discharge | | |
| HBM | Human Body Model | | |
| MM | Machine Model | | |
| | | | |

16. Revision history

| Table 12. Revisio | on history | | | |
|-------------------|---------------------------------------|----------------------------------|---------------|-----------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| 74LVC1GU04 v.12 | 20130409 | Product data sheet | - | 74LVC1GU04 v.11 |
| Modifications: | Descriptive title | e changed to Unbuffered inverter | - | |
| 74LVC1GU04 v.11 | 20120702 | Product data sheet | - | 74LVC1GU04 v.10 |
| Modifications: | Added type nu | mber 74LVC1GU04GX (SOT122 | 26) | |
| | Package outling | ne drawing of SOT886 (Figure 16 |) modified. | |
| 74LVC1GU04 v.10 | 20111201 | Product data sheet | - | 74LVC1GU04 v.9 |
| Modifications: | Legal pages u | pdated. | | |
| 74LVC1GU04 v.9 | 20101021 | Product data sheet | - | 74LVC1GU04 v.8 |
| 74LVC1GU04 v.8 | 20070612 | Product data sheet | - | 74LVC1GU04 v.7 |
| 74LVC1GU04 v.7 | 20061006 | Product data sheet | - | 74LVC1GU04 v.6 |
| 74LVC1GU04 v.6 | 20040921 | Product specification | - | 74LVC1GU04 v.5 |
| 74LVC1GU04 v.5 | 20040628 | Product specification | - | 74LVC1GU04 v.4 |
| 74LVC1GU04 v.4 | 20030630 | Product specification | - | 74LVC1GU04 v.3 |
| 74LVC1GU04 v.3 | 20030212 | Product specification | - | 74LVC1GU04 v.2 |
| 74LVC1GU04 v.2 | 20010406 | Product specification | - | 74LVC1GU04 v.1 |
| 74LVC1GU04 v.1 | 20001212 | Product specification | - | - |

17. Legal information

17.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Unbuffered inverter

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